IoT SuperServer SYS-210SE-31A



Key Applications

- Multi-Access Edge Computing
- Flex-RAN, Open-RAN vBBU
- Telecom DRAN, CRAN, and Edge Core Application
- Enterprise Edge Computing

Key Features

Three hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- 1. Single Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable processor (per node)
- 2. 8 DIMMs; Up to 2TB 3DS ECC DDR4-3200: RDIMM/LRDIMM (per node)
- 3. 2 PCI-E Gen4 x16 FHHL slot and 1 PCI-E Gen4 x16 HHHL slot (per node)
- 4. 2 NVMe M.2 2280/22110 (per node)
- 5. 4 counter-rotated fan speed control (per node); 1 Air Shroud (per node)
- 6. Front-access 2000W AC Redundant Power Supplies

Specifications

Product SKUs

SYS-210SE-31A SuperServer SYS-210SE-31A (Silver)

Motherboard

Super X12SPED-F

Processor (per Node)

С	Ρ	U

- Single Socket P+ (LGA-4189)
- 3rd Gen Intel® Xeon® Scalable processors
- Support CPU TDP 85-205W

Three hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

 Please contact Supermicro Technical Support for supporting conditions of high power (TDP >205W) processors.

Cores

Up to 32C/64T; Up to 48MB Cache

System Memory (per Node)

Memory

Memory Capacity: 8 DIMM slotsMemory Type: 3200MHz ECC DDR4 RDIMM/LRDIMM

LAN and KVM-over-LAN support

Memory Voltage ■ 1.2 V

Error Detection _ ECC

On-Board Devices (per Node)

Chipset	■ Intel® C621A
Network Connectivity	■ 1x 1GbE BaseT port(s)
IPMI	 Support for Intelligent Platform Management Interface v.2.0 IPMI 2.0 with virtual media over

Input / Output (per Node)

1 RJ45 GbE LAN port (Shared NIC	
■ 1 VGA port(s)	
■ 1 COM Port(s) (1 COM)	
 1 KVM dongle (output VGA x1, COM x1, USB 2.0 x2 through KVM cable) 	

Management

Software	■ SuperDoctor® 5		
	■ IPMI 2.0		

Chassis

Form Factor	2U Rackmount
Model	■ CSE-SE201-R2K07P
Note	 16.9" (430mm) chassis depth Front access IO design, and tool less serviceability Three front hot-swappable nodes with single CPU socket and 8 DIMM design

Dimensions and Weight

Height	■ 3.5" (88mm)
Width	■ 17.7" (449mm)
Depth	■ 16.9" (430mm)
Package	■ 9.5" (H) x 29.5" (W) x 23.2" (D)
Weight	Net Weight: 55.1 lbs (25 kg)Gross Weight: 70.6 lbs (32 kg)
Available Color	■ Silver

Front Panel

Buttons	Power On/OffUID button
LEDs	 HDD activity LAN1 activity LAN2 activity Power status System information

Expansion Slots (per Node)

PCI-Express	■ Slot 1: 1 PCle PCI-E 4.0 x16 LP
(PCI-E)	■ Slot 2: 1 PCIe PCI-E 4.0 x16
	FHHL
	Slot 3: 1 PCIe PCI-E 4.0 x16
	FHHI

Drive Bays / Storage (per Node)

Drive Bays	■ N/A
M.2	■ 2 M.2 NVMe ■ M-Key, 2280/22110

System Cooling

Fans	 12 heavy duty fans with optimal fan speed control (4 fans per node)
Air Shroud	■ 1 Air Shroud(s)

Power Supply

2000W Redundant AC 100-240V Power Supply		
Dimension	■ 73.5 x 40 x 265 mm	
(W x H x L)		

Power Configurations PC Health Monit	recovery	AC Input	 1000W: 100-127Vac / 9A-12A / 50-60Hz 1800W: 200-220Vac / 9.8A-10A / 50-60Hz 2000W: 220-240Vac / 10A-11A / 50-60Hz
CPU	 Monitors for CPU Cores, Chipset Voltages, Memory 	+12V	Max: 83A / Min: 0A (100Vac- 127Vac)
FAN	 Fans with tachometer monitoring Pulse Width Modulated (PWM) fan connectors Status monitor for speed control 		 Max: 150A / Min: 0A (200Vac- 220Vac) Max: 166A / Min: 0A (220Vac- 240Vac)
Temperature	 CPU thermal trip support, PEPI Monitoring for CPU and chassis environment 	Certification	[<u>Test Report</u>]

Operating Environment

Environmental Spec.

- Operating Temperature: 0°C ~ 55°C (32°F ~ 131°F)
- Non-operating Temperature: -40°C to 70°C (-40°F to 158°F)
- Operating Relative Humidity: 8% to 90% (non-condensing)
- Non-operating Relative Humidity: 5% to 95% (non-condensing)

Parts List

Parts List - (Items Included)

	Part Number	Qty	Description
Motherboard / Chassis	MBD-X12SPED-F	3	Super X12SPED-F Motherboard
	CSE-SE201-R2K07P	1	2U Chassis
Add-on Card / Module	AOM-BPN-SE3N-P	1	Backplane for SuperEdge 2U3N,RoHS
Cable 1	CBL-0218L	1	11.5CM KVM/SUVI 36PIN TO 9PIN/15PIN/2USB
Riser Card	RSC-W-66G4	3	1U LHS WIO Riser card with two PCI-E 4.0 x16 slots,HF,RoHS
Riser Card	RSC-WR-6	3	1U RHS WIO Riser card with one PCI-E 4.0 x16 slot,HF,RoHS
Software	SFT-OOB-LIC	3	License key for enabling OOB BIOS management
Heatsink / Retention	SNK-P1044V	3	1U Passive CPU Heat Sink for B12 ICX/CPX CPU
*Power Supply	PWS-2K07F-1R	2	1U 2000W 90-264Vac/47-63Hz, wide DC input 180Vdc- 300Vdc, 12V
*Power Distributor	PDB-PT201-DSG	2	Super Edge pass through board support Ultra powers up to 6KW
*Rail Set	MCP-290-20101-0N	1	2U fixed rail set, quick release, default for 2,3U , 17.6"W, 18.5-22

Notes:

- Parts with * are inside the chassis
 Excessive parts might not be shipped, including but not limited to excessive drive trays, fans, riser brackets, air shrouds, IO shields, cables.....etc.

Optional Parts List

	Part Number	Qty	Description
TPM security module	<u>AOM-TPM-9670V</u>	-	SPI capable TPM 2.0 with Infineon 9670 controller with vertical form factor